

1A, 200V - 600V Surface Mount Ultra Fast Rectifiers

FEATURES

- Ideal for automated placement
- Ultra fast recovery time for high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _{F(AV)}	1	А	
V _{RRM}	200-600	V	
I _{FSM}	30	А	
T _{J MAX}	150	°C	
Package	SOD-123W		
Configuration	Single dice		

APPLICATIONS

• For use in high voltage, high frequency power factor corrections, switching mode power supplies, freewheeling diodes and secondary dc to dc rectifications



MECHANICAL DATA

- Case: SOD-123W
- Molding compound, UL flammability classification rating 94V-0
- Moisture sensitivity level: level 1, per J-STD-020
- Part No. with suffix "H" means AEC-Q101 qualified
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 16 mg (approximately)



SOD-123W

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C	unless oth	erwise note	d)		
PARAMETER	SYMBOL	UF1DLW	UF1GLW	UF1JLW	UNIT
Marking code on the device		UDLW	UGLW	UJLW	
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	V
Maximum RMS voltage	V _{RMS}	140	280	420	V
Maximum DC blocking voltage	V _{DC}	200	400	600	V
Maximum average forward rectified current	I _{F(AV)}		1		А
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}		30		А
Operating Junction and Storage Temperature Range	T _J , T _{STG}		- 55 to +150		°C



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Junction to Lead Thermal Resistance	R _{ejl}	28	°C/W
Junction to Ambient Thermal Resistance	R _{eja}	88	°C/W
Junction to Case Thermal Resistance	R _{ejc}	38	°C/W

Thermal Performance Note: Units mounted on recommended PCB (5mm x 5mm Cu test board)

ELECTRICAL SPEC	CIFICATIO	NS (T _A = 25°C unless	otherwise note	ed)		
PARAMETER		CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Maximum instantaneous forward voltage (Note 1)	UF1DLW UF1GLW UF1JLW	I _F = 1A	V _F	-	0.95 1.25 1.5	V
Maximum reverse current		T _J = 25°C	– I _R	-	1	μA
@ rated V _R (Note 2)		T _J = 125°C	K	-	50	μA
	UF1DLW	1 MHz, V _R =4.0V	CJ	40	-	pF
Junction capacitance	UF1GLW			25	-	
	UF1JLW			15	-	
Reverse recovery time	UF1DLW UF1GLW UF1JLW	I _F =0.5A , I _R =1.0A I _{RR} =0.25A	t _{rr}	-	20 20 25	ns

Notes:

1. Pulse test with PW=0.3 ms

2. Pulse test with PW=30 ms



ORDERING INFORMATION

PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING
UF1xLW	н	RV	0		3,000 / 7" Plastic reel
(Note 1, 2)	П	RQ	G	SOD-123W	10,000 / 13" Paper reel

Note 1: "x" defines voltage from 200V (UF1DLW) to 600V (UF1JLW) Note 2: Whole series with green compound (halogen-free)

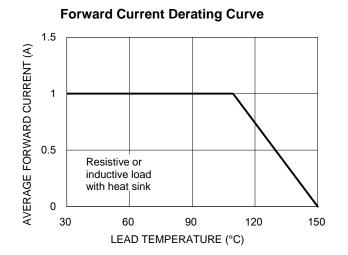
EXAMPLE

EXAMPLE P/N	PART NO.	PART NO. SUFFIX	PACKING Code	PACKING CODE SUFFIX	DESCRIPTION
UF1DLWHRVG	UF1DLW	н	RV	G	AEC-Q101 qualified Green compound



CHARACTERISTICS CURVES

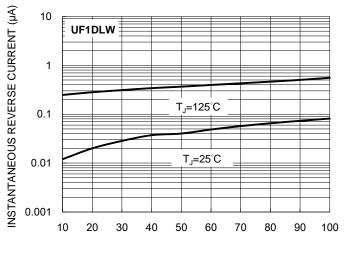
(T_A = 25°C unless otherwise noted)



100 **UF1DLW** UF1GLW 10 1 **UF1JLW** f=1.0MHz Vsig=50mVp-p 0.1 20 80 0 40 60 100 REVERSE VOLTAGE (V)

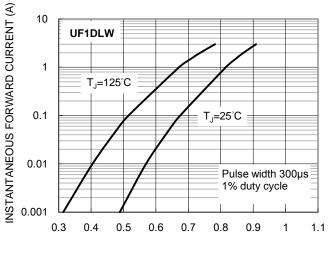
Typical Junction Capacitance

TYPICAL REVERSE CHARACTERISTICS



PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

TYPICAL FORWARD CHARACTERISTICS



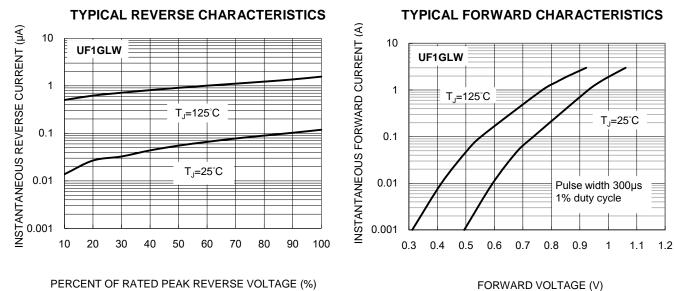
FORWARD VOLTAGE (V)

CAPACITANCE (pF)



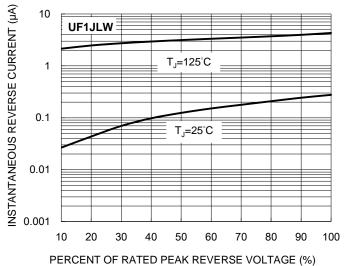
CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

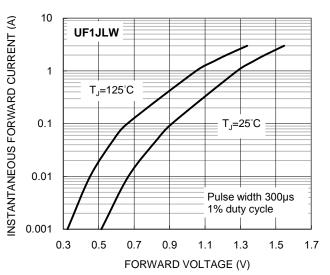


PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

TYPICAL REVERSE CHARACTERISTICS



TYPICAL FORWARD CHARACTERISTICS





UF1DLW - UF1JLW Taiwan Semiconductor

Unit (inch)

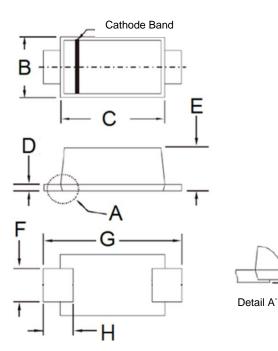
Min

Max

PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

SOD-123W

DIM



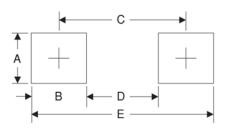
В	1.70	1.90	0.067	0.075
С	2.60	2.90	0.102	0.114
D	0.10	0.22	0.004	0.009
Е	0.90	1.02	0.035	0.040
F	0.90	1.05	0.035	0.041
G	3.60	3.80	0.142	0.150
Н	0.50	0.85	0.020	0.033
I	0.00	0.10	0.000	0.004

Max

Unit (mm)

Min

SUGGESTED PAD LAYOUT (Unit: Millimeters)



Symbol	Unit (mm)	Unit (inch)
А	1.4	0.055
В	1.2	0.047
С	3.1	0.122
D	1.9	0.075
E	4.3	0.169

MARKING DIAGRAM



P/N	= Marking Code
YW	= Date Code
F	= Factory Code

Version:A1608



Taiwan Semiconductor

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